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ATTORNEY DOCKET NO. CONFIRMATION NO.

APPLICATION NO. FILING DATE FIRST NAMED INVENTOR CU-3290 RJS 6419 07/14/2003 Chae Kyu Jang 10/618,955 **EXAMINER** 26530 7590 05/23/2005 LADAS & PARRY LLP PAREKH, NITIN 224 SOUTH MICHIGAN AVENUE PAPER NUMBER ART UNIT **SUITE 1200** CHICAGO, IL 60604 2811

DATE MAILED: 05/23/2005

Please find below and/or attached an Office communication concerning this application or proceeding.

			H·A
	Application No.	Applicant(s)	
<i>Off</i> ic e Action <i>Summ</i> a <i>ry</i>	10/618,955	JANG ET AL.	
	Exa m n er	A/t Unit	
	Nitin Parekh	2811	
The MAILING DATE of this communication ap Period for Reply	pears on the cover sheet	with the correspondence address	
A SHORTENED STATUTORY PERIOD FOR REPL THE MAILING DATE OF THIS COMMUNICATION. - Extensions of time may be available under the provisions of 37 CFR 1. after SIX (6) MONTHS from the mailing date of this communication. - If the period for reply specified above is less than thirty (30) days, a rep If NO period for reply is specified above, the maximum statutory period Failure to reply within the set or extended period for reply will, by statut Any reply received by the Office later than three months after the mailing earned patent term adjustment. See 37 CFR 1.704(b).	.136(a). In no event, however, may oly within the statutory minimum of the light will apply and will expire SIX (6) More than the cause the application to become	a reply be timely filed hirty (30) days will be considered timely. ONTHS from the mailing date of this communic ABANDONED (35 U.S.C. § 133).	ation.
Status			
 1) Responsive to communication(s) filed on 03-2 2a) This action is FINAL. 2b) This 3) Since this application is in condition for allowed closed in accordance with the practice under 	s action is non-final. ance except for formal m	•	s is
Disposition of Claims			
4) ☐ Claim(s) 1-6 is/are pending in the application. 4a) Of the above claim(s) is/are withdra 5) ☐ Claim(s) is/are allowed. 6) ☐ Claim(s) 1-6 is/are rejected. 7) ☐ Claim(s) is/are objected to. 8) ☐ Claim(s) are subject to restriction and/a	awn from consideration.		
Application Papers			
9) The specification is objected to by the Examin		4	
10)⊠ The drawing(s) filed on 14 July 2003 is/are: a) accepted or b) objected to by the Examiner.			
Applicant may not request that any objection to the	***)1/d\
Replacement drawing sheet(s) including the correct 11) The oath or declaration is objected to by the E	·	= : : : :	
Priority under 35 U.S.C. § 119			
a) Acknowledgment is made of a claim for foreign a) All b) Some * c) None of: 1. Certified copies of the priority document 2. Certified copies of the priority document 3. Copies of the certified copies of the priority application from the International Bureat * See the attached detailed Office action for a list	nts have been received. Its have been received in only documents have been (PCT Rule 17.2(a)).	Application No en received in this National Stage	
Attach // Ent(s)			
1) Notice of References Cited (PTO-892) 2) Notice of Draftsperson's Patent Drawing Review (PTO-948) 3) Information Disclosure Statement(s) (PTO-1449 or PTO/SB/08 Paper No(s)/Mail Date 38-15-23	Paper N	v Summary (PTO-413) o(s)/Mail Date f Informal Patent Application (PTO-152) 	

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DETAILED ACTION

Claim Rejections - 35 USC § 103

- 1. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
 - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 2. Claims 1-6 are rejected under 35 U.S.C. 103(a) as being unpatentable over Kinsman (US Pat. Application Pub. 2002/0038442) in view of the admitted prior art (APA).

Regarding claims 1-6, Kinsman disclose a ball grid array (BGA) package comprising:

- a printed circuit board (PCB- 2 in Fig. 9) having bonding sites/fingers/pads
- an adhesive material (not numerically referenced in Fig. 9) being coated on the edges of the PCB (50/54 in section 0031)
- a sealing frame/sealing post (SF/SP-12/26 in Fig. 9) made of a barrier material including an insulating/non-conductive material (see sections 0030/0031) being adhered on the adhesive material/PCB, the SF/SP including a recess/lip/extrusion at an upper end (see 66 in Fig. 9; section 0034)
- a semiconductor chip having a plurality of bonding pads (52/56 in Fig. 8/9)
 adhered on the PCB, the chip being the edge-pad type chip

a plurality of aluminum/metal wires (60 in Fig. 9) separately connecting bonding
 pads of the chip to the bonding sites/fingers of the PCB

- a sealing cover/cap (SC-62 in Fig. 9) made of an insulating/non-conductive material such as glass/quartz (see section 0032) being adhered on the extrusion/recessed portion of the SF/SP, the SC sealing the semiconductor chip
- the SC being adhered on the extrusion/recessed portion of the SF/SP using conventional adhesive material including an adhesive tape/low temperature thermoplastic tape (see sections 0031-0034), and
- a plurality of conductive elements/solder balls (see 74 in Fig. 13; section 0036)
 adhered to a lower side of the PCB

(Fig. 9; Fig. 8 and 13; sections 30-36 and 24-29).

Kinsman fails to teach the package being a test vehicle comprising a testing chip.

The APA teaches using conventional packages in a form of a test vehicle package to test semiconductor chips (see specification pages 1–3).

It would have been obvious to a person of ordinary skill in the art at the time invention was made to incorporate the BGA package being a test vehicle comprising the testing chip as taught by APA so that the testing and characterization capability can be enhanced in Kinsman's BGA.

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Response to Arguments

3. Applicant's arguments filed on 03-17-05 have been fully considered but they are not persuasive.

A. Applicant contends that Kinsman's BGA in Fig. 2-3C and sections 0026-0030, do teach the recess/lip/extrusion at an upper end of the sealing post.

However, Kinsman clearly teaches the sealing frame/post having the recess/lip/extrusion at the upper end (see 66 in the structure 12/26 in Fig. 9; section 0034).

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Nitin Parekh whose telephone number is 571-272-1663. The examiner can normally be reached on 09:00AM-05:30PM.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Eddie Lee can be reached on 571-272-1732. The fax phone number for the organization where this application or proceeding is assigned is 703-872-9318.

Any inquiry of a general nature or relating to the status of this application or proceeding should be directed to the receptionist whose telephone number is 703-308-0956.

NP

NITIN PAREKH

05-18-05

PRIMARY EXAMINER

TECHNOLOGY CENTER 2800